

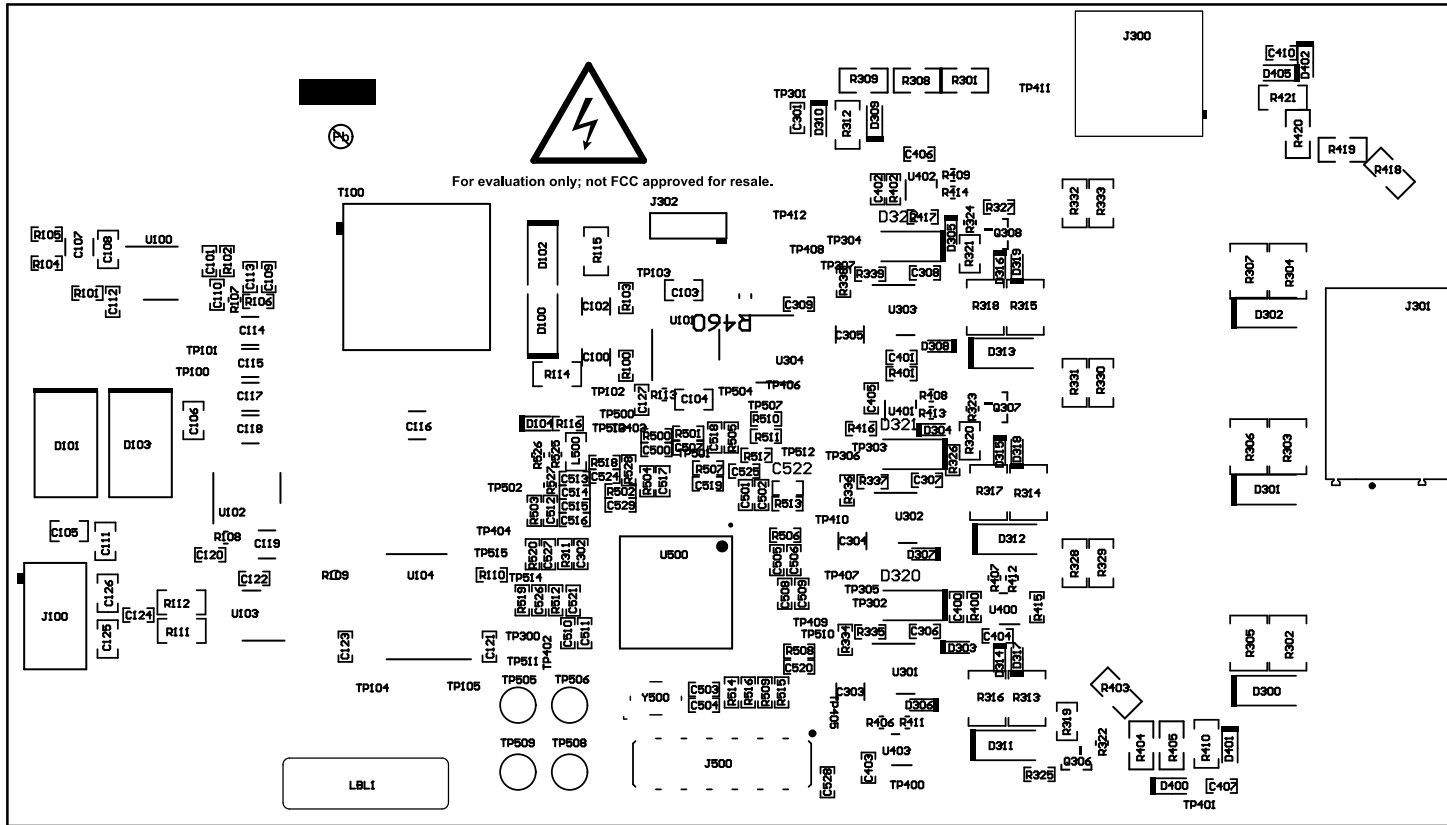
ZZ2
ZZ3
ZZ4

H1

Logo1 Logo2 Logo3 Logo4

ZZ1

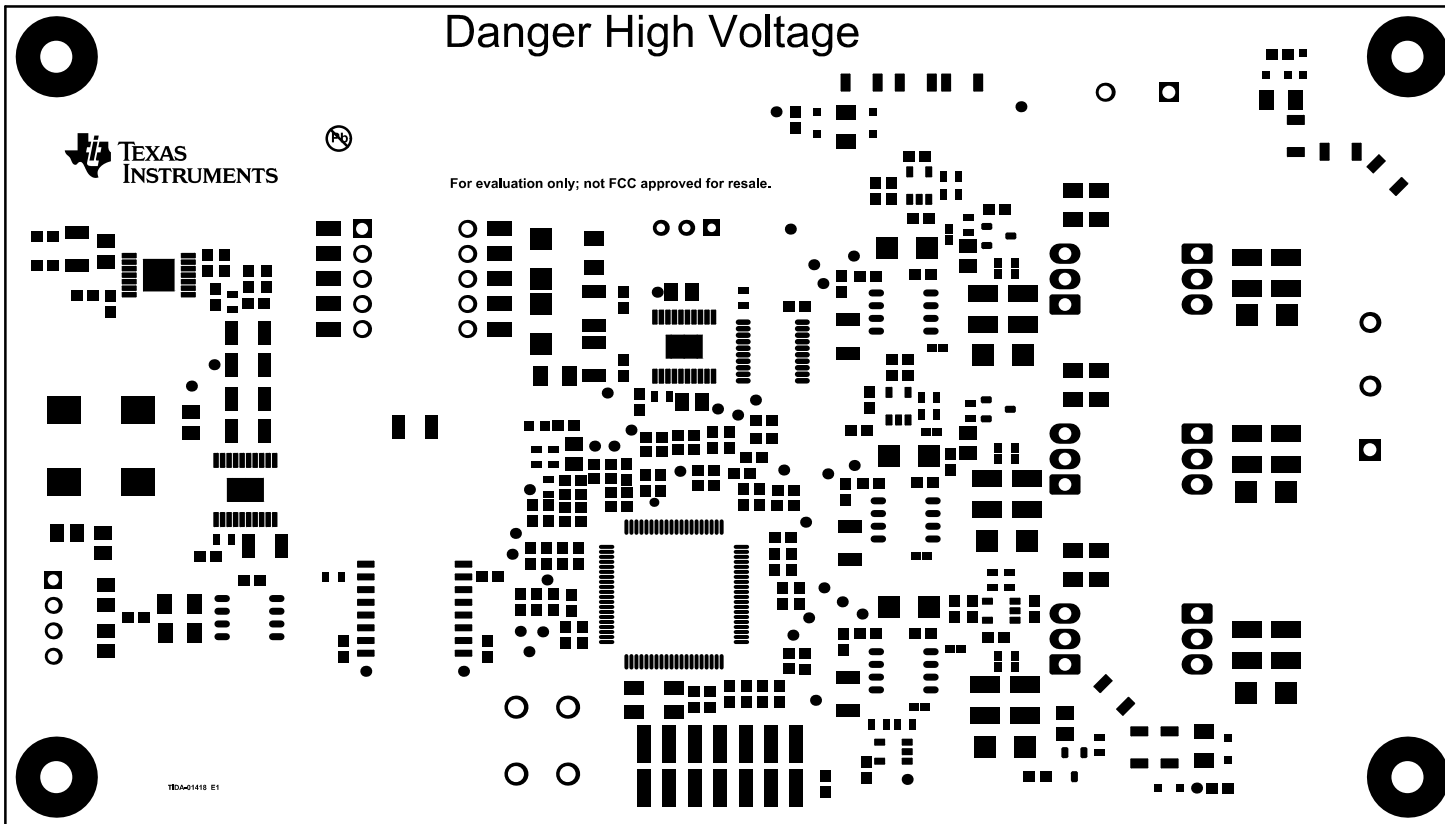
H2



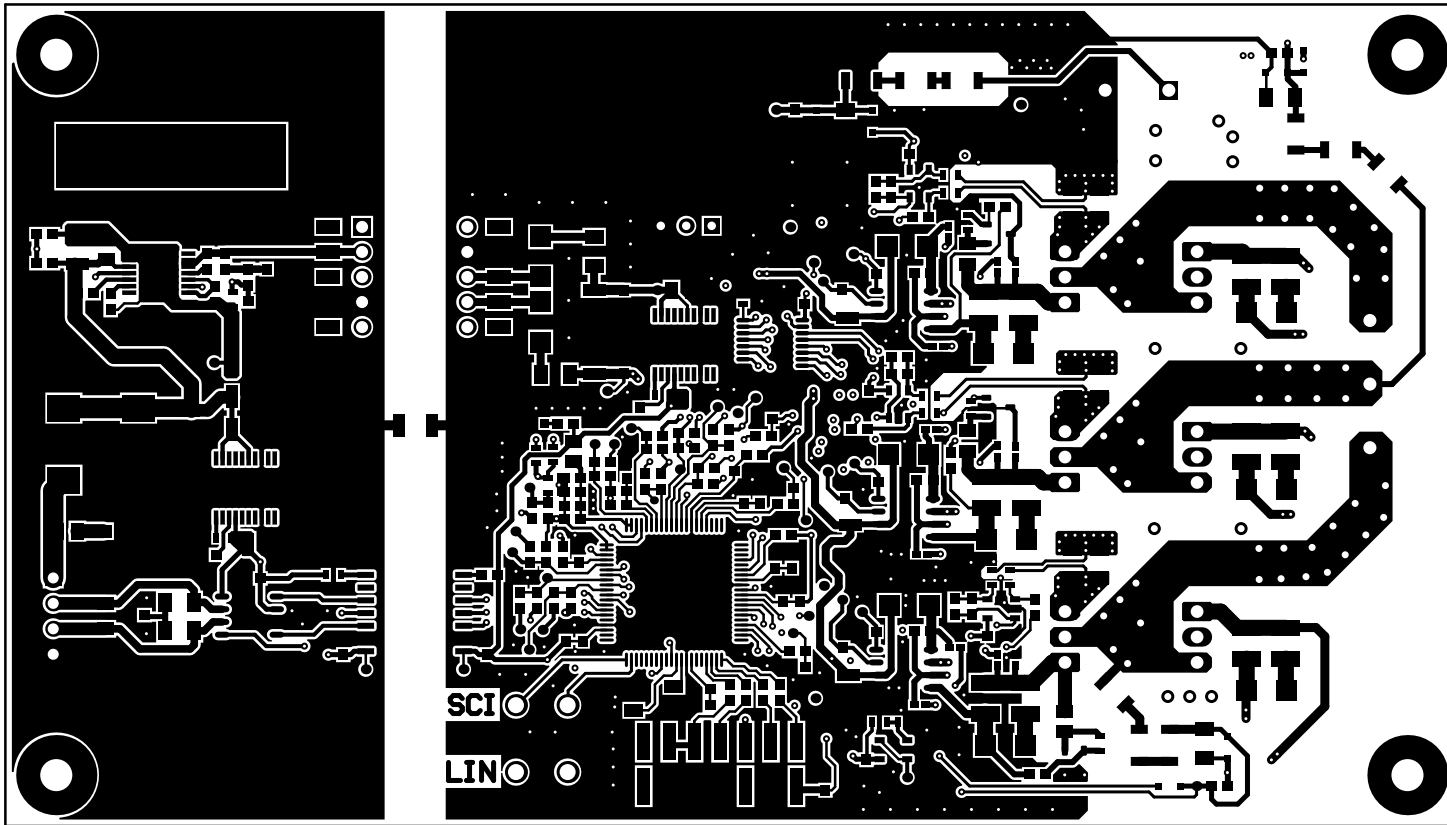
H3

H4

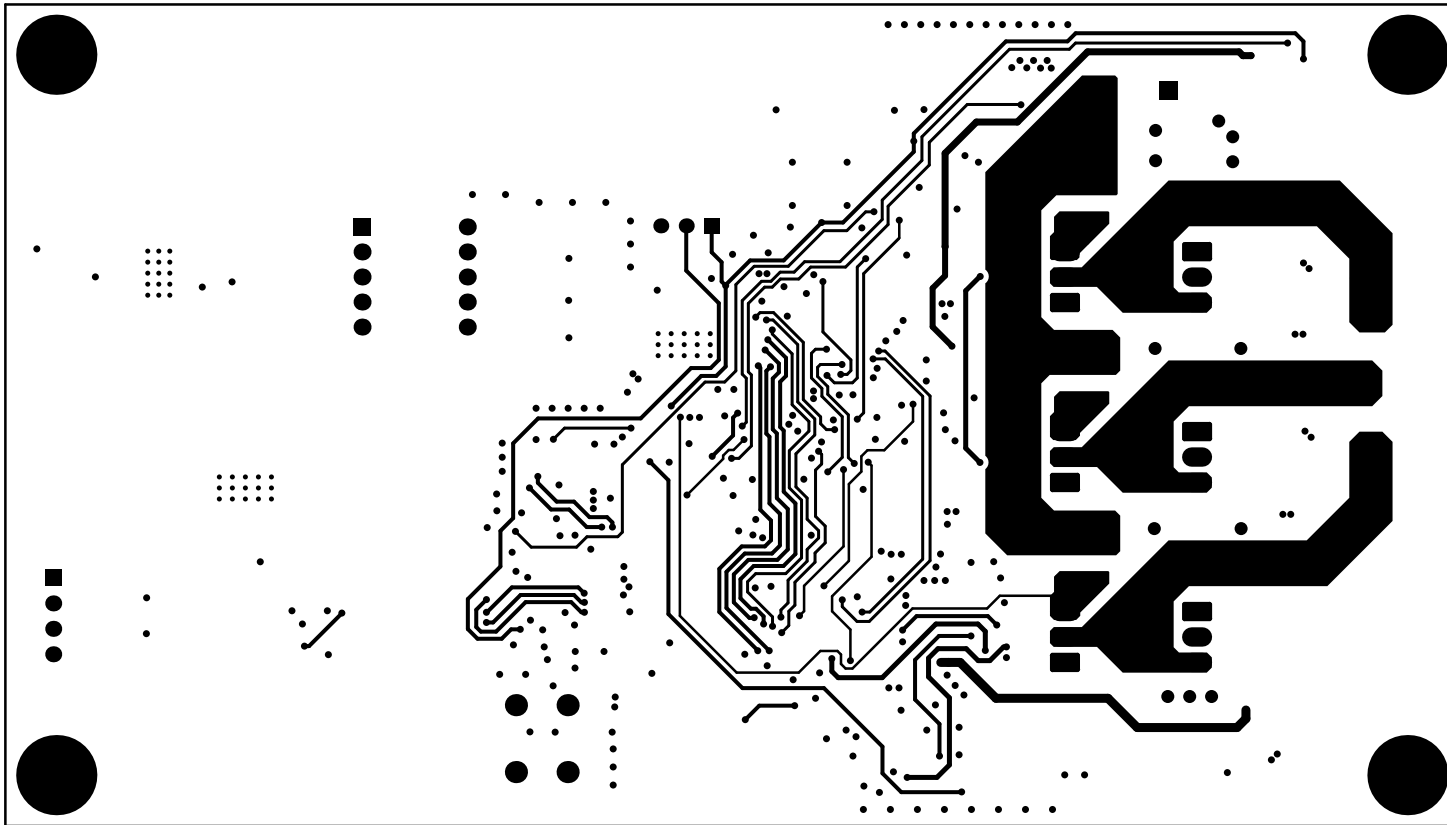
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	TIDA-01418	REV:	E1	SUN REV:	Not In VersionControl
LAYER NAME =	Top Overlay	TID #:	TIDA-01418			
PLOT NAME =	Top Overlay	GENERATED :	11/24/2017	3:06:31 PM	TEXAS INSTRUMENTS	



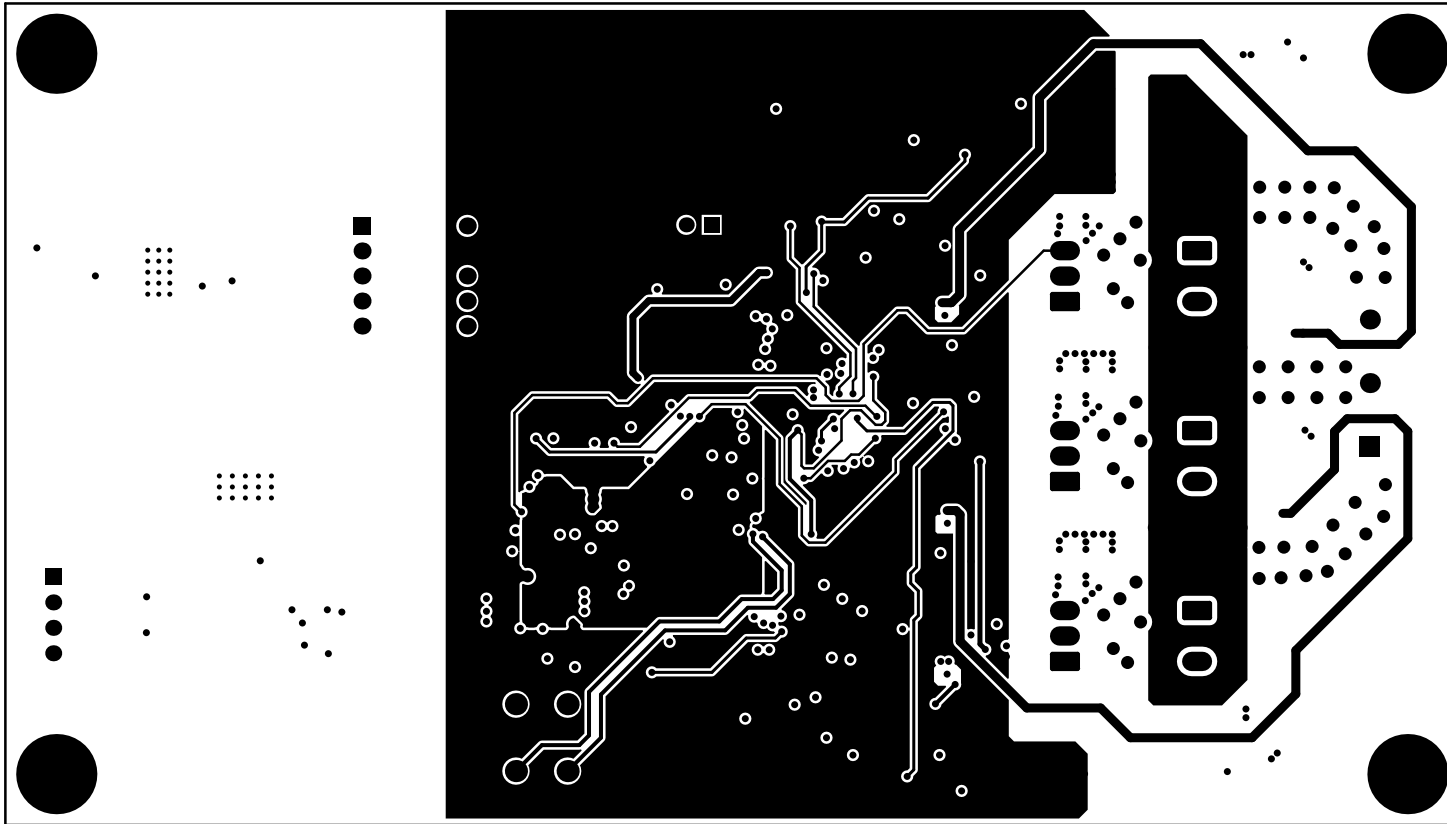
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01418	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01418		
PLOT NAME = Top Solder Mask	GENERATED : 11/24/2017	3:06:32 PM	TEXAS INSTRUMENTS



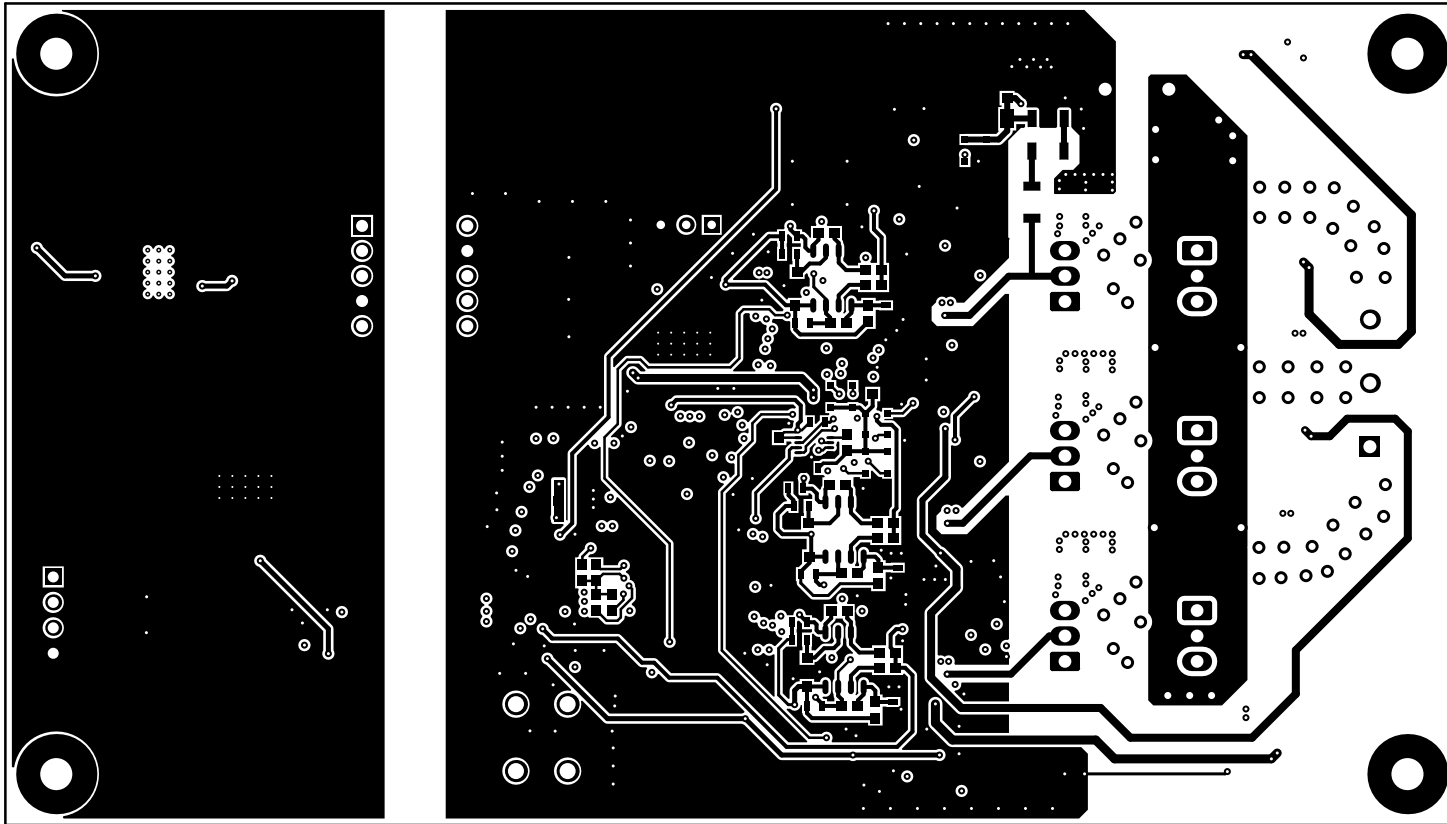
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01418	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01418		
PLOT NAME = Top Layer	GENERATED : 11/24/2017 3:06:33 PM		TEXAS INSTRUMENTS



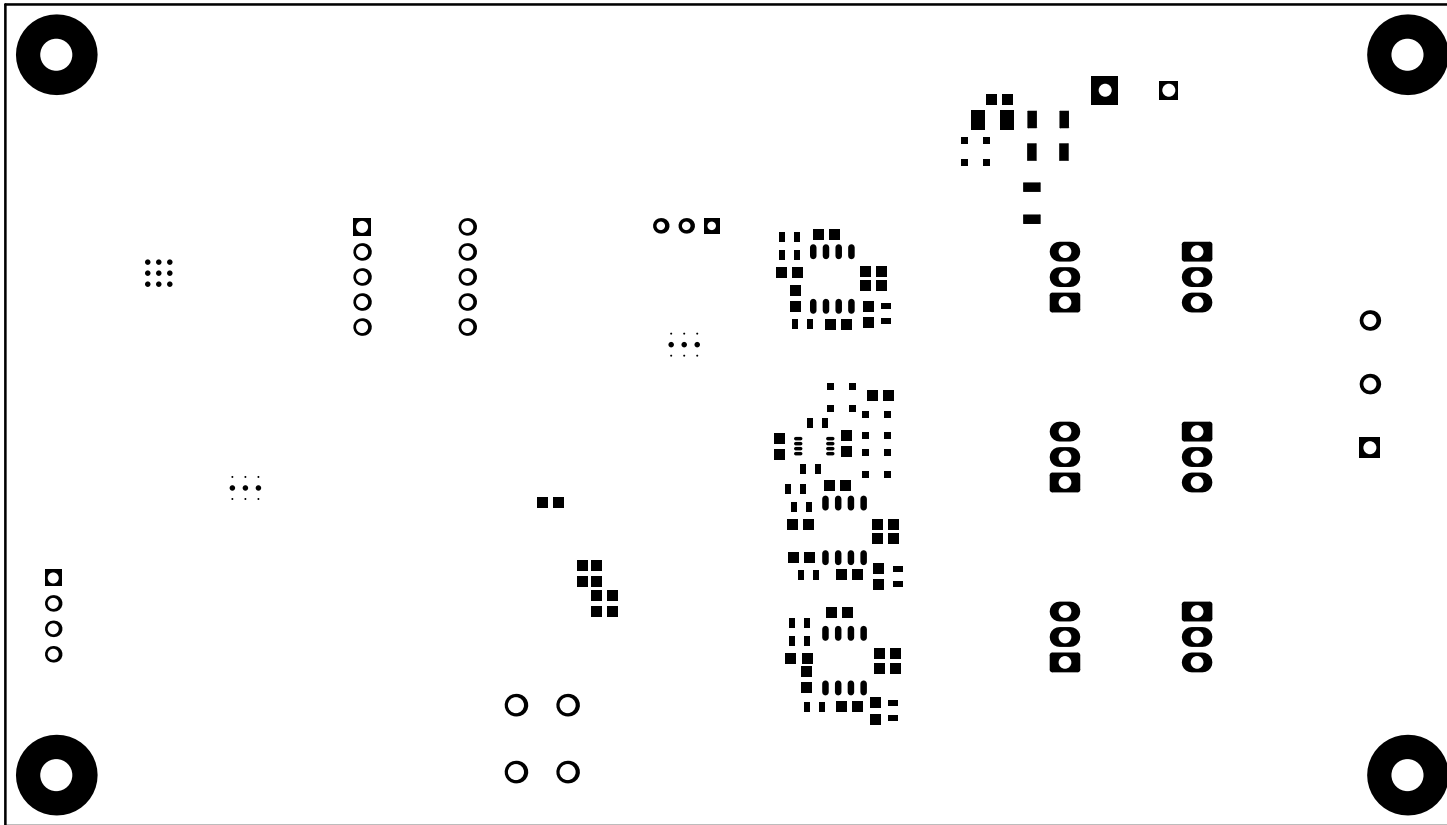
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	TIDA-01418	REV:	E1	SUN REV:	Not In VersionControl
LAYER NAME =	TID #:	TIDA-01418				
PLOT NAME =	Signal 1	GENERATED :	11/24/2017	3:06:34 PM	TEXAS INSTRUMENTS	



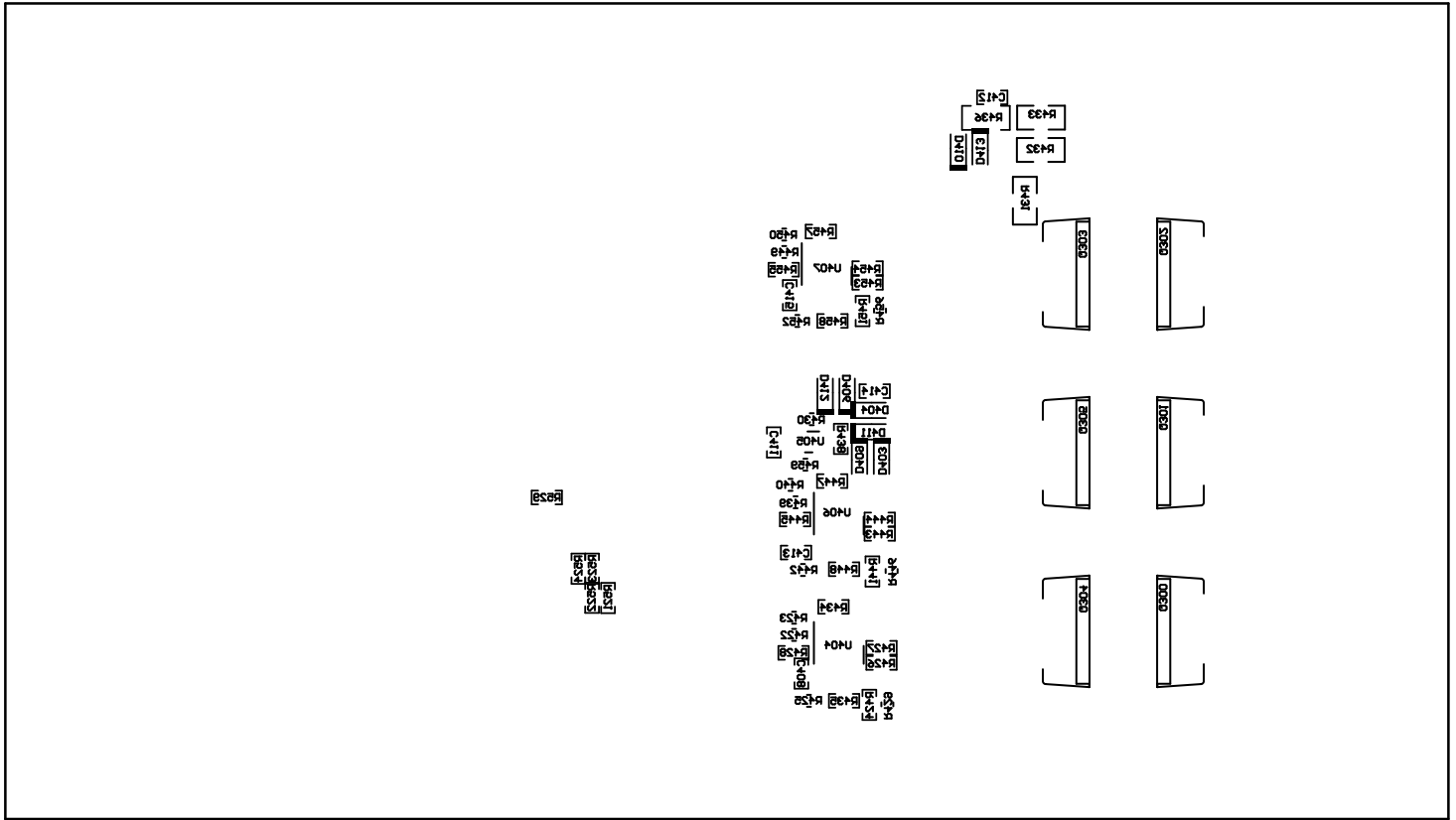
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	TIDA-01418	REV:	E1	SUN REV:	Not In VersionControl
LAYER NAME =	TID #:	TIDA-01418				
PLOT NAME =	Signal 2	GENERATED :	11/24/2017	3:06:34 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	TIDA-01418	REV:	E1	SUN REV:	Not In VersionControl
LAYER NAME =	Bottom Layer	TID #:	TIDA-01418			
PLOT NAME =	Bottom Layer	GENERATED :	11/24/2017	3:06:35 PM	TEXAS INSTRUMENTS	

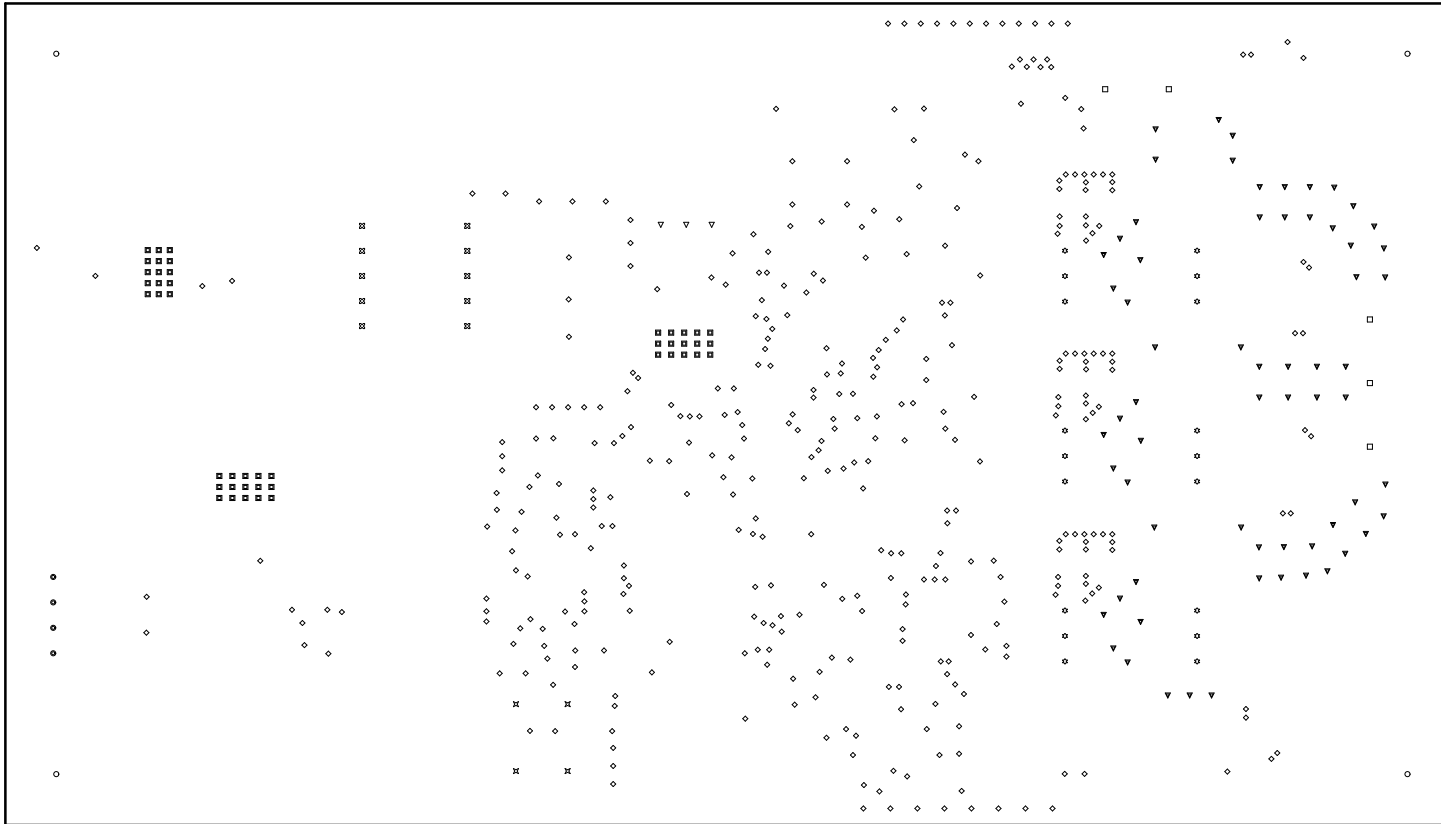


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01418	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01418		
PLOT NAME = Bottom Solder Mask	GENERATED : 11/24/2017 3:06:36 PM	TEXAS INSTRUMENTS	

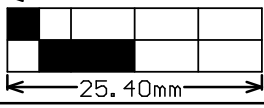


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	TIDA-01418	REV:	E1	SUN REV:	Not In VersionControl
LAYER NAME =	Bottom Overlay	TID #:	TIDA-01418			
PLOT NAME =	Bottom Overlay	GENERATED :	11/24/2017	3:06:37 PM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
■	45	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
◆	389	11.81mil (0.300mm)	PTH	Round	Top Layer - Bottom Layer	
▼	65	27.56mil (0.700mm)	PTH	Round	Top Layer - Bottom Layer	
▽	3	33.47mil (0.850mm)	PTH	Round	Top Layer - Bottom Layer	
●	4	43.31mil (1.100mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	10	47.24mil (1.200mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	18	50.00mil (1.270mm)	PTH	Round	Top Layer - Bottom Layer	
□	5	51.18mil (1.300mm)	PTH	Round	Top Layer - Bottom Layer	
×	4	63.00mil (1.600mm)	PTH	Round	Top Layer - Bottom Layer	
○	4	125.98mil (3.200mm)	PTH	Round	Top Layer - Bottom Layer	
	547 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01418	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01418		
PLOT NAME = Drill Drawing	GENERATED : 11/24/2017 3:06:38 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01418	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-01418		
PLOT NAME = Board Dimensions	GENERATED : 11/24/2017 3:06:40 PM	TEXAS INSTRUMENTS	

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